

Product Specification

XBLW SN74HC126

Quad Buffer/Line Driver; 3-state

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Description

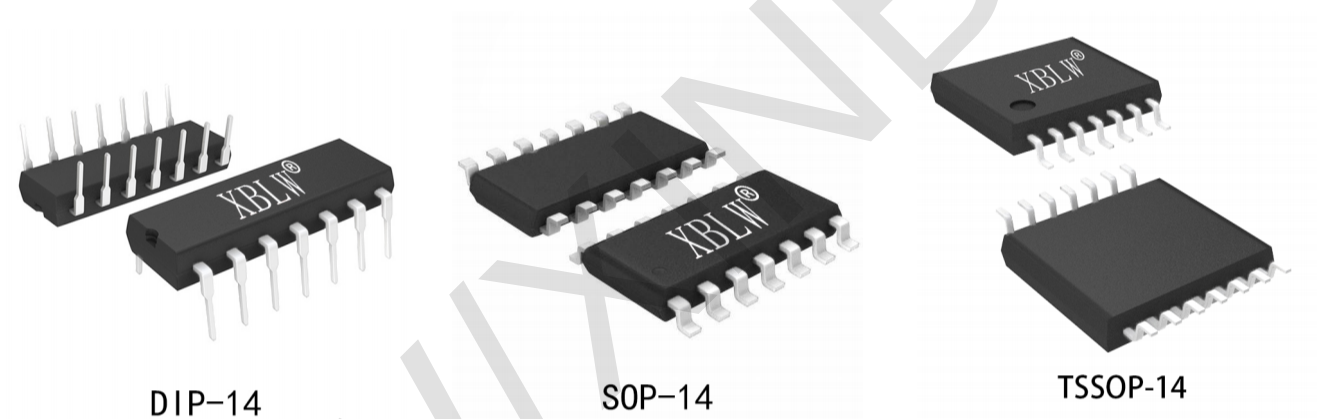
The SN74HC126 is a quad buffer/line driver with 3-state outputs controlled by the output enable inputs (nOE) . A LOW on nOE causes the outputs to assume a high-impedance OFF-state. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of V_{CC} .

Features

Buffered inputs
 Wide operating voltage range: 2 V to 6 V
 Inverting outputs
 Specified from -40°C to +125°C
 Packaging information: DIP-14/SOP-14/TSSOP-14

Applications

Enable digital signals



Ordering Information

Product Model	Package Type	Marking	Packing	Packing Qty
XBLW SN74HC126N	DIP-14	74HC126N	Tube	1000Pcs/Box
XBLW SN74HC126DTR	SOP-14	74HC126	Tape	2500Pcs/Reel
XBLW SN74HC126TDTR	TSSOP-14	74HC126	Tape	3000Pcs/Reel

Block Diagram

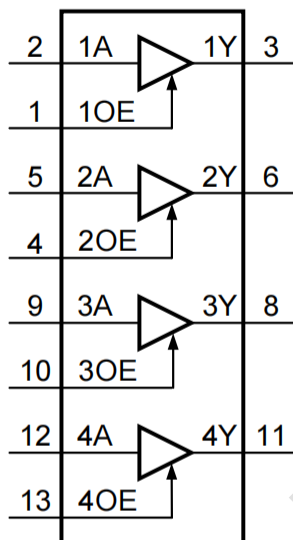


Figure 1. Logic symbol

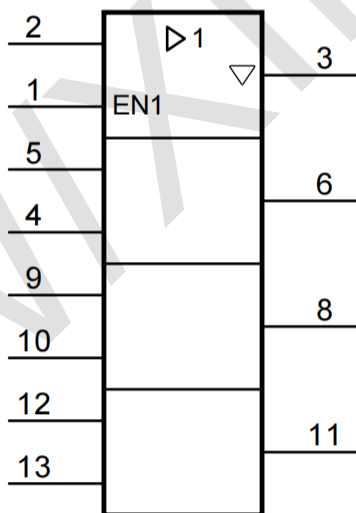


Figure 2. IEC logic symbol

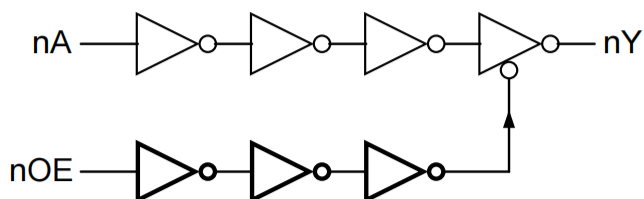
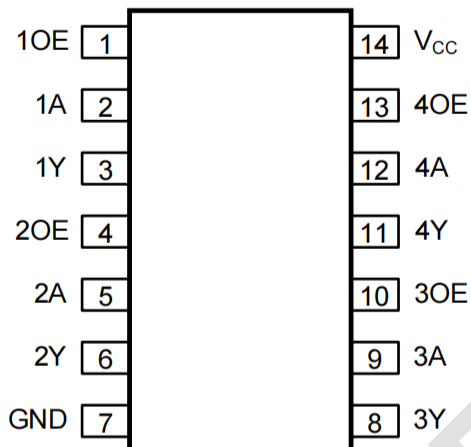


Figure 3. Logic diagram for one gate

Pin Configurations



Pin Description

Pin No.	Pin Name	Description
1	1OE	output enable input (active HIGH)
2	1A	data input
3	1Y	data output
4	2OE	output enable input (active HIGH)
5	2A	data input
6	2Y	data output
7	GND	ground (0V)
8	3Y	data output
9	3A	data input
10	3OE	output enable input (active HIGH)
11	4Y	data output
12	4A	data input
13	4OE	output enable input (active HIGH)
14	V _{cc}	supply voltage

Function Table

Control	Input	Output
nOE	nA	nY
H	L	L
H	H	H
L	X	Z

Note: H=HIGH voltage level; L=LOW voltage level; X=don't care; Z=high-impedance OFF-state.

Electrical Parameter

Absolute Maximum Ratings

(Voltages are referenced to GND (ground=0V), unless otherwise specified.)

Parameter	Symbol	Conditions	Min.	Max.	Unit
supply voltage	V_{CC}	-	-0.5	+7	V
input clamping current	I_{IK}	$V_I < -0.5V$ or $V_I > V_{CC}+0.5V$	-	± 20	mA
output clamping current	I_{OK}	$V_O < -0.5V$ or $V_O > V_{CC}+0.5V$	-	± 20	mA
output current	I_O	$-0.5V < V_O < V_{CC}+0.5V$	-	± 35	mA
supply current	I_{CC}	-	-	70	mA
ground current	I_{GND}	-	-70	-	mA
total power dissipation	P_{tot}	-	-	500	mW
storage temperature	T_{stg}	-	-65	+150	°C
soldering temperature	T_L	10s	DIP SOP/TSSOP	245 260	°C

Recommended Operating Conditions

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
supply voltage	V_{CC}	-	2.0	5.0	6.0	V
input voltage	V_I	-	0	-	V_{CC}	V
output voltage	V_O	-	0	-	V_{CC}	V
input transition rise and fall rate	$\Delta t/\Delta V$	$V_{CC}=2.0V$	-	-	625	ns/V
		$V_{CC}=4.5V$	-	1.67	139	ns/V
		$V_{CC}=6.0V$	-	-	83	ns/V
ambient temperature	T_{amb}	-	-40	-	+125	°C

Electrical Characteristics

DC Characteristics 1

($T_{amb}=25^{\circ}\text{C}$, voltages are referenced to GND (ground=0V), unless otherwise specified.)

Parameter	Symbol	Conditions		Min.	Typ.	Max.	Unit
HIGH-level input voltage	V_{IH}	$V_{CC}=2.0V$		1.5	1.2	-	V
		$V_{CC}=4.5V$		3.15	2.4	-	V
		$V_{CC}=6.0V$		4.2	3.2	-	V
LOW-level input voltage	V_{IL}	$V_{CC}=2.0V$		-	0.8	0.5	V
		$V_{CC}=4.5V$		-	2.1	1.35	V
		$V_{CC}=6.0V$		-	2.8	1.8	V
HIGH-level output voltage	V_{OH}	$V_I=V_{IH}$ or V_{IL}	$I_O=-20\mu A$; $V_{CC}=2.0V$	1.9	2.0	-	V
			$I_O=-20\mu A$; $V_{CC}=4.5V$	4.4	4.5	-	V
			$I_O=-20\mu A$; $V_{CC}=6.0V$	5.9	6.0	-	V
			$I_O=-6.0mA$; $V_{CC}=4.5V$	3.98	4.32	-	V
			$I_O=-7.8mA$; $V_{CC}=6.0V$	5.48	5.81	-	V
LOW-level output voltage	V_{OL}	$V_I=V_{IH}$ or V_{IL}	$I_O=20\mu A$; $V_{CC}=2.0V$	-	0	0.1	V
			$I_O=20\mu A$; $V_{CC}=4.5V$	-	0	0.1	V
			$I_O=20\mu A$; $V_{CC}=6.0V$	-	0	0.1	V
			$I_O=6.0mA$; $V_{CC}=4.5V$	-	0.15	0.26	V
			$I_O=7.8mA$; $V_{CC}=6.0V$	-	0.16	0.26	V
input leakage current	I_I	$V_I=V_{CC}$ or GND; $V_{CC}=6.0V$		-	-	± 1	μA
OFF-state output current	I_{OZ}	$V_I=V_{IH}$ or V_{IL} ; $V_O=V_{CC}$ or GND; $V_{CC}=6.0V$		-	-	± 1	μA
supply current	I_{CC}	$V_I=V_{CC}$ or GND; $I_O=0A$; $V_{CC}=6.0V$		-	-	8.0	μA
input capacitance	C_I	-		-	3.5	-	pF

DC Characteristics 2

($T_{amb} = -40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$, voltages are referenced to GND (ground=0V), unless otherwise specified.)

Parameter	Symbol	Conditions		Min.	Typ.	Max.	Unit
HIGH-level input voltage	V_{IH}	$V_{CC}=2.0V$		1.5	-	-	V
		$V_{CC}=4.5V$		3.15	-	-	V
		$V_{CC}=6.0V$		4.2	-	-	V
LOW-level input voltage	V_{IL}	$V_{CC}=2.0V$		-	-	0.5	V
		$V_{CC}=4.5V$		-	-	1.35	V
		$V_{CC}=6.0V$		-	-	1.8	V
HIGH-level output voltage	V_{OH}	$V_I=V_{IH}$ or V_{IL}	$I_O=-20\mu A$; $V_{CC}=2.0V$	1.9	-	-	V
			$I_O=-20\mu A$; $V_{CC}=4.5V$	4.4	-	-	V
			$I_O=-20\mu A$; $V_{CC}=6.0V$	5.9	-	-	V
			$I_O=-6.0mA$; $V_{CC}=4.5V$	3.84	-	-	V
			$I_O=-7.8mA$; $V_{CC}=6.0V$	5.34	-	-	V
LOW-level output voltage	V_{OL}	$V_I=V_{IH}$ or V_{IL}	$I_O=20\mu A$; $V_{CC}=2.0V$	-	-	0.1	V
			$I_O=20\mu A$; $V_{CC}=4.5V$	-	-	0.1	V
			$I_O=20\mu A$; $V_{CC}=6.0V$	-	-	0.1	V
			$I_O=6.0mA$; $V_{CC}=4.5V$	-	-	0.33	V
			$I_O=7.8mA$; $V_{CC}=6.0V$	-	-	0.33	V
input leakage current	I_I	$V_I=V_{CC}$ or GND; $V_{CC}=6.0V$		-	-	± 1	μA
OFF-state output current	I_{OZ}	$V_I=V_{IH}$ or V_{IL} ; $V_O=V_{CC}$ or GND; $V_{CC}=6.0V$		-	-	± 5	μA
supply current	I_{CC}	$V_I=V_{CC}$ or GND; $I_O=0A$; $V_{CC}=6.0V$		-	-	80	μA

DC Characteristics 3

($T_{amb} = -40^{\circ}\text{C}$ to $+125^{\circ}\text{C}$, voltages are referenced to GND (ground=0V) unless otherwise specified)

Parameter	Symbol	Conditions		Min.	Typ.	Max.	Unit
HIGH-level input voltage	V _{IH}	V _{CC} =2.0V		1.5	-	-	V
		V _{CC} =4.5V		3.15	-	-	V
		V _{CC} =6.0V		4.2	-	-	V
LOW-level input voltage	V _{IL}	V _{CC} =2.0V		-	-	0.5	V
		V _{CC} =4.5V		-	-	1.35	V
		V _{CC} =6.0V		-	-	1.8	V
HIGH-level output voltage	V _{OH}	V _I =V _{IH} or V _{IL}	I _O =-20uA; V _{CC} =2.0V	1.9	-	-	V
			I _O =-20uA; V _{CC} =4.5V	4.4	-	-	V
			I _O =-20uA; V _{CC} =6.0V	5.9	-	-	V
			I _O =-6.0mA; V _{CC} =4.5V	3.7	-	-	V
			I _O =-7.8mA; V _{CC} =6.0V	5.2	-	-	V
LOW-level output voltage	V _{OL}	V _I =V _{IH} or V _{IL}	I _O =20uA; V _{CC} =2.0V	-	-	0.1	V
			I _O =20uA; V _{CC} =4.5V	-	-	0.1	V
			I _O =20uA; V _{CC} =6.0V	-	-	0.1	V
			I _O =6.0mA; V _{CC} =4.5V	-	-	0.4	V
			I _O =7.8mA; V _{CC} =6.0V	-	-	0.4	V
input leakage current	I _I	V _I =V _{CC} or GND; V _{CC} =6.0V		-	-	± 1	uA
OFF-state output current	I _{OZ}	V _I =V _{IH} orV _{IL} ; V _O = V _{CC} or GND; V _{CC} =6.0V		-	-	±10	uA
supply current	I _{CC}	V _I =V _{CC} or GND; I _O =0A; V _{CC} =6.0V		-	-	160	uA

AC Characteristics 1

($T_{amb}=25^{\circ}C$, voltages are referenced to GND (ground=0V), unless otherwise specified.)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
nA to nY propagation delay	t_{pd}	see Figure 5 ^[1]	$V_{CC}=2.0V$	-	30	100 ns
			$V_{CC}=4.5V$	-	11	20 ns
			$V_{CC}=5.0V; C_L=15pF$	-	9	- ns
			$V_{CC}=6.0V$	-	9	17 ns
nOE to nY enable time	t_{en}	see Figure 6 ^[2]	$V_{CC}=2.0V$	-	41	125 ns
			$V_{CC}=4.5V$	-	15	25 ns
			$V_{CC}=6.0V$	-	12	21 ns
nOE to nY disable time	t_{dis}	see Figure 6 ^[3]	$V_{CC}=2.0V$	-	41	125 ns
			$V_{CC}=4.5V$	-	15	25 ns
			$V_{CC}=6.0V$	-	12	21 ns
transition time	t_t	see Figure 5 ^[4]	$V_{CC}=2.0V$	-	14	60 ns
			$V_{CC}=4.5V$	-	5	12 ns
			$V_{CC}=6.0V$	-	4	10 ns
power dissipation capacitance	C_{PD}	per package; $V_I=GND$ to $V_{CC}-1.5V$ ^[5]	-	23	-	pF

Note:

[1] t_{pd} is the same as t_{PLH} and t_{PHL} .

[2] t_{en} is the same as t_{PZL} and t_{PZH} .

[3] t_{dis} is the same as t_{PLZ} and t_{PHZ} .

[4] t_t is the same as t_{THL} and t_{TLH} .

[5] C_{PD} is used to determine the dynamic power dissipation (P_D in uW).

$P_D=(C_{PD} \times V_{CC}^2 \times f_i \times N) + \Sigma(C_L \times V_{CC}^2 \times f_o)$ where:

f_i =input frequency in MHz;

f_o =output frequency in MHz;

C_L =output load capacitance in pF;

V_{CC} =supply voltage in V;

N =number of inputs switching;

$\Sigma(C_L \times V_{CC}^2 \times f_o)$ =sum of outputs.

AC Characteristics 2

($T_{amb} = -40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$, voltages are referenced to GND (ground=0V), unless otherwise specified.)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
nA to nY propagation delay	t_{pd}	see Figure 5 ^[1]	$V_{CC}=2.0\text{V}$	-	-	125 ns
			$V_{CC}=4.5\text{V}$	-	-	25 ns
			$V_{CC}=6.0\text{V}$	-	-	21 ns
nOE to nY enable time	t_{en}	see Figure 6 ^[2]	$V_{CC}=2.0\text{V}$	-	-	155 ns
			$V_{CC}=4.5\text{V}$	-	-	31 ns
			$V_{CC}=6.0\text{V}$	-	-	26 ns
nOE to nY disable time	t_{dis}	see Figure 6 ^[3]	$V_{CC}=2.0\text{V}$	-	-	155 ns
			$V_{CC}=4.5\text{V}$	-	-	31 ns
			$V_{CC}=6.0\text{V}$	-	-	26 ns
transition time	t_t	see Figure 5 ^[4]	$V_{CC}=2.0\text{V}$	-	-	75 ns
			$V_{CC}=4.5\text{V}$	-	-	15 ns
			$V_{CC}=6.0\text{V}$	-	-	13 ns

Note:

[1] t_{pd} is the same as t_{PLH} and t_{PHL} .

[2] t_{en} is the same as t_{PZL} and t_{PZH} .

[3] t_{dis} is the same as t_{PLZ} and t_{PHZ} .

[4] t_t is the same as t_{THL} and t_{TLH} .

AC Characteristics 3

($T_{amb} = -40^{\circ}\text{C}$ to $+125^{\circ}\text{C}$, voltages are referenced to GND (ground=0V), unless otherwise specified.)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
nA to nY propagation delay	t_{pd}	see Figure 5 ^[1]	$V_{CC}=2.0\text{V}$	-	-	150 ns
			$V_{CC}=4.5\text{V}$	-	-	30 ns
			$V_{CC}=6.0\text{V}$	-	-	26 ns
nOE to nY enable time	t_{en}	see Figure 6 ^[2]	$V_{CC}=2.0\text{V}$	-	-	190 ns
			$V_{CC}=4.5\text{V}$	-	-	38 ns
			$V_{CC}=6.0\text{V}$	-	-	32 ns
nOE to nY disable time	t_{dis}	see Figure 6 ^[3]	$V_{CC}=2.0\text{V}$	-	-	190 ns
			$V_{CC}=4.5\text{V}$	-	-	38 ns
			$V_{CC}=6.0\text{V}$	-	-	32 ns
transition time	t_t	see Figure 5 ^[4]	$V_{CC}=2.0\text{V}$	-	-	90 ns
			$V_{CC}=4.5\text{V}$	-	-	18 ns
			$V_{CC}=6.0\text{V}$	-	-	15 ns

Note:

[1] t_{pd} is the same as t_{PLH} and t_{PHL} .

[2] t_{en} is the same as t_{PZL} and t_{PZH} .

[3] t_{dis} is the same as t_{PLZ} and t_{PHZ} .

[4] t_t is the same as t_{THL} and t_{TLH} .

Testing Circuit

AC Testing Circuit

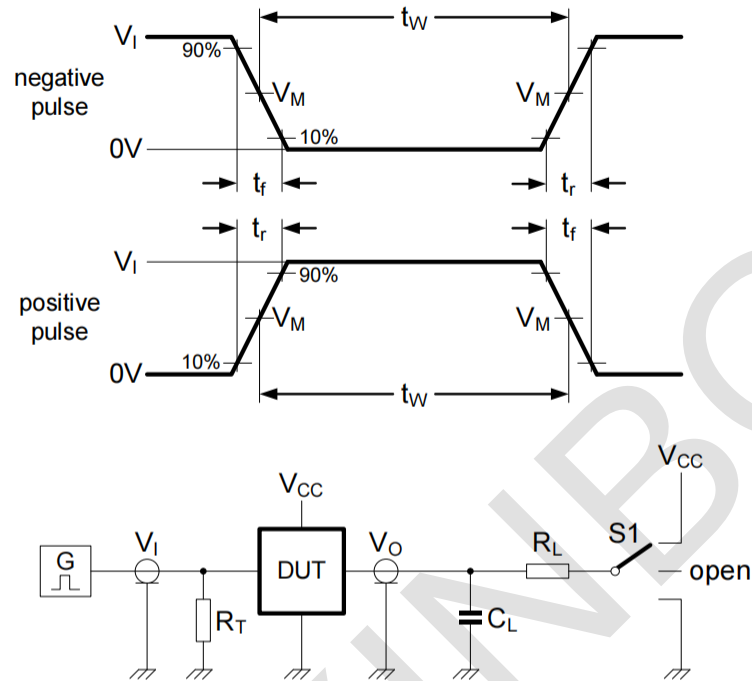


Figure 4. Test circuit for measuring switching times

Definitions for test circuit:

C_L =load capacitance including jig and probe capacitance.

R_T =termination resistance should be equal to the output impedance Z_o of the pulse generator.

R_L = Load resistance.

S1 = Test selection switch.

AC Testing Waveforms

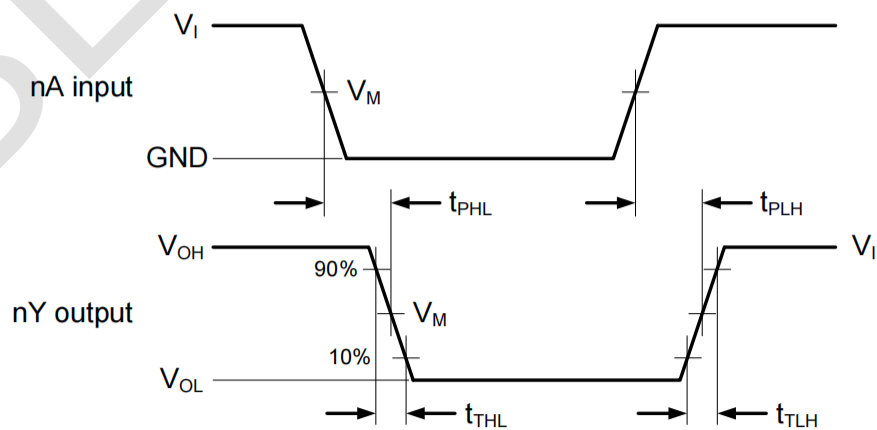


Figure 5. Input (nA) to output (nY) propagation delays

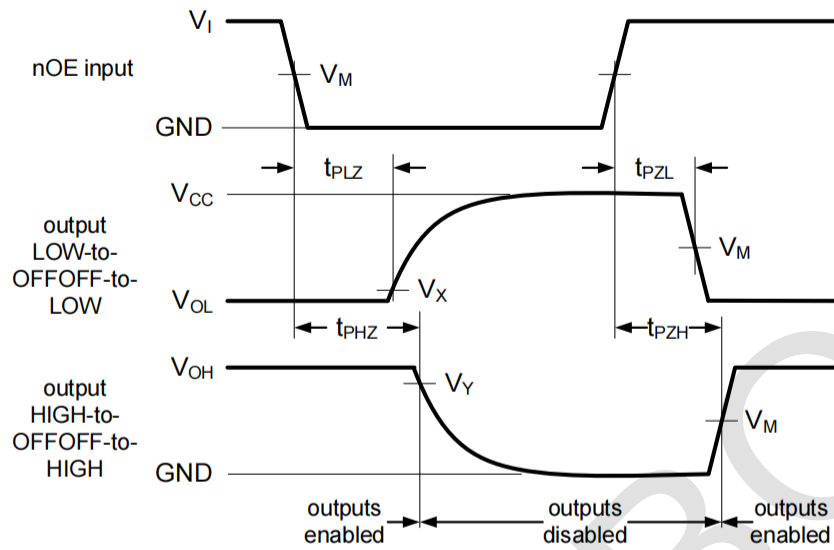


Figure 6. Enable and disable times

Measurement Points

Type	Input	Output		
	V_M	V_M	V_X	V_Y
SN74HC126	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	$0.1 \times V_{CC}$	$0.9 \times V_{CC}$

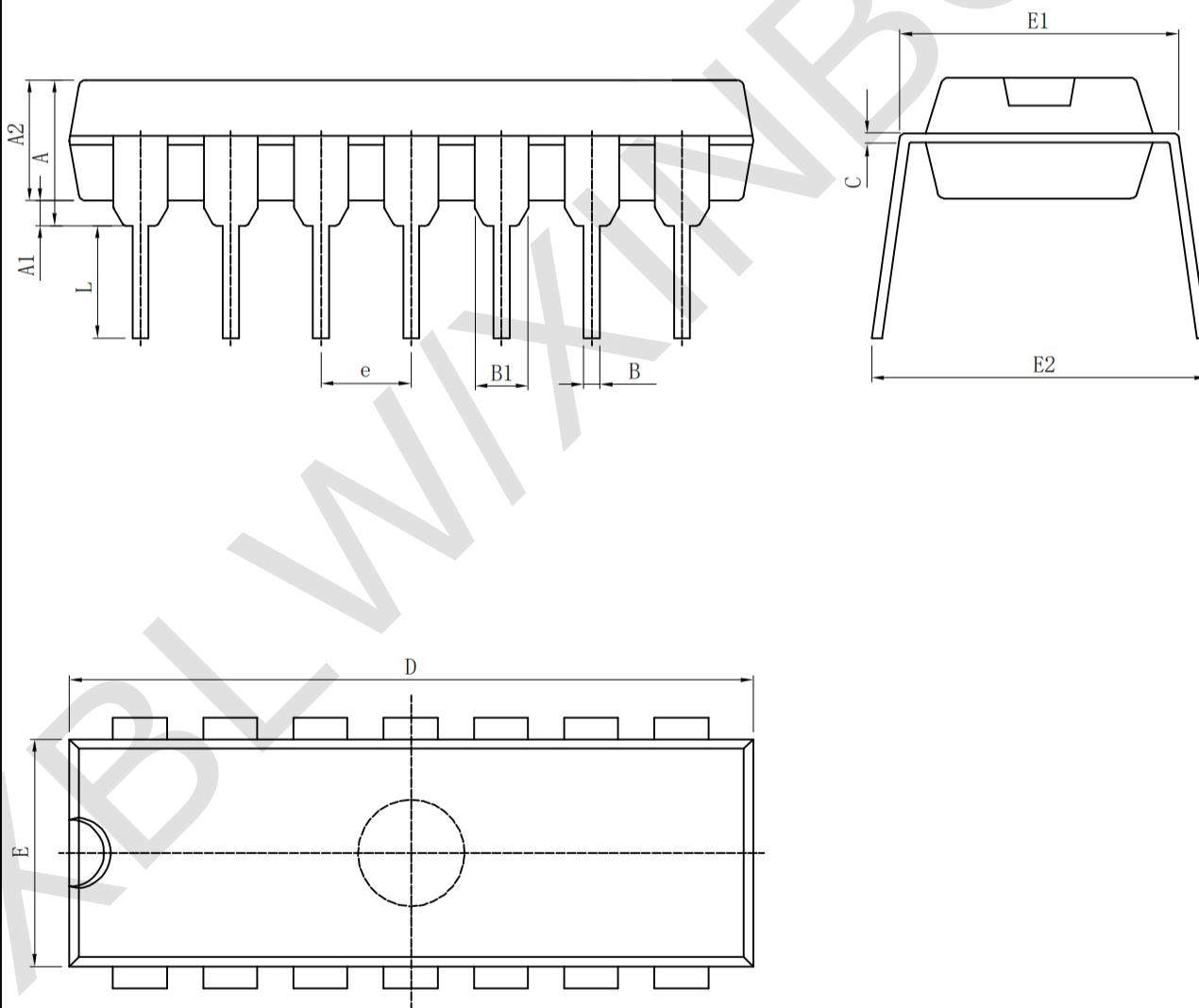
Test Data

Type	Input		Load		S1 position		
	V_I	t_r, t_f	C_L	R_L	t_{PHL}, t_{PLH}	t_{PZH}, t_{PHZ}	t_{PZL}, t_{PLZ}
SN74HC126	V_{CC}	6.0ns	15pF, 50pF	1k Ω	open	GND	V_{CC}

Package Information

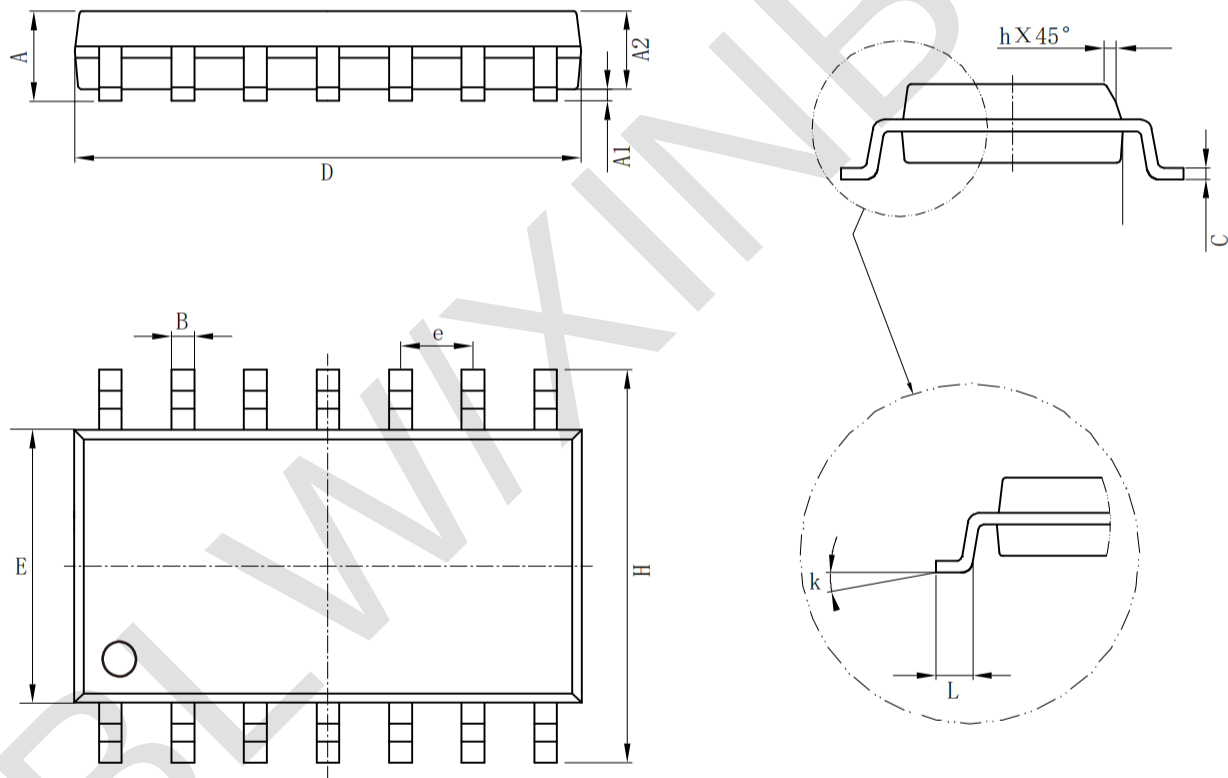
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Symbol	Size	Dimensions In Millimeters		Symbol	Size	Dimensions In Inches	
		Min (mm)	Max (mm)			Min (in)	Max (in)
A		3.710	4.310	A		0.146	0.170
A1		0.510		A1		0.020	
A2		3.200	3.600	A2		0.126	0.142
B		0.380	0.570	B		0.015	0.022
B1		1.524 (BSC)		B1		0.060 (BSC)	
C		0.204	0.360	C		0.008	0.014
D		18.800	19.200	D		0.740	0.756
E		6.200	6.600	E		0.244	0.260
E1		7.320	7.920	E1		0.288	0.312
e		2.540 (BSC)		e		0.100 (BSC)	
L		3.000	3.600	L		0.118	0.142
E2		8.400	9.000	E2		0.331	0.354



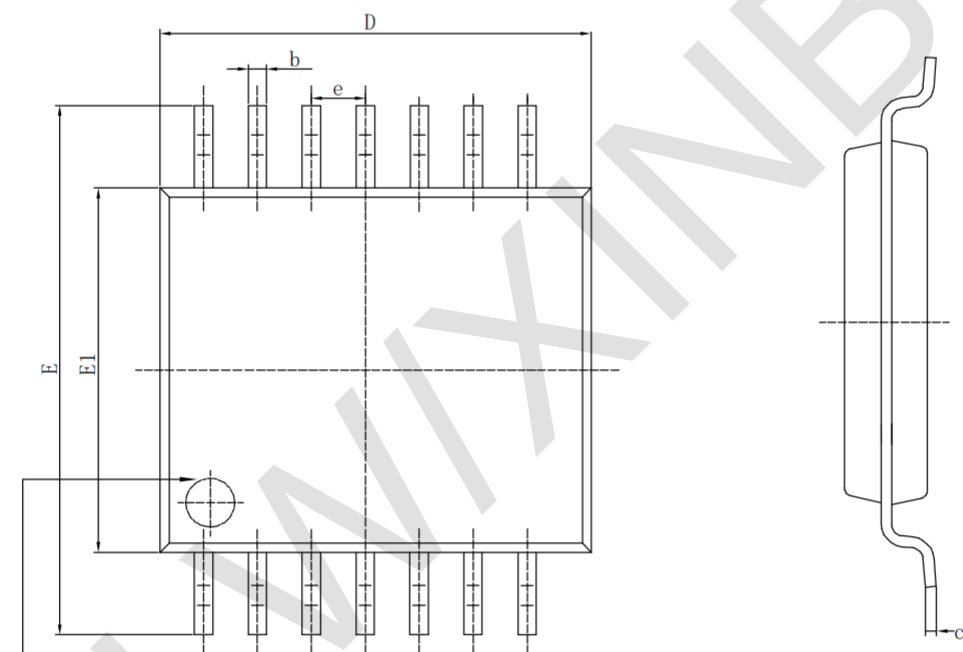
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Size Symbol	Dimensions In Millimeters		Size Symbol	Dimensions In Inches	
	Min(mm)	Max(mm)		Min(in)	Max(in)
A	1.350	1.750	A	0.050	0.068
A1	0.100	0.250	A1	0.004	0.009
A2	1.100	1.650	A2	0.040	0.060
B	0.330	0.510	B	0.010	0.020
C	0.190	0.250	C	0.007	0.009
D	8.550	8.750	D	0.330	0.340
E	3.800	4.000	E	0.150	0.150
e	1.27		e	0.05	
H	5.800	6.200	H	0.220	0.240
h	0.250	0.500	h	0.009	0.020
L	0.400	1.270	L	0.015	0.050
k	8° (max)		k	8° (max)	

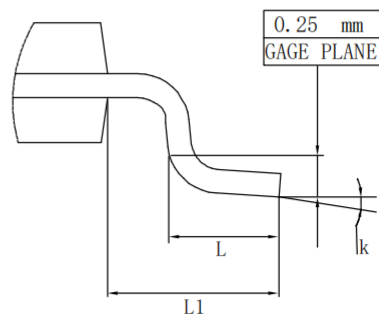
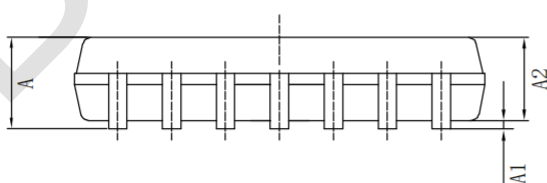


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Symbol \ Size	Dimensions In Millimeters		Symbol \ Size	Dimensions In Inches	
	Min (mm)	Max (mm)		Min (in)	Max (in)
A		1.200	A		0.047
A1	0.050	0.150	A1	0.002	0.006
A2	0.800	1.050	A2	0.031	0.041
b	0.190	0.300	b	0.007	0.012
c	0.090	0.200	c	0.004	0.0089
D	4.900	5.100	D	0.193	0.201
E	6.200	6.600	E	0.244	0.260
E1	4.300	4.500	E1	0.169	0.176
e	0.65		e	0.0256	
L	0.450	0.750	L	0.018	0.030
L1	1.00		L1	0.039	
k	0°	8°	k	0°	8°



PIN #1 IDENT.



Statement

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